

LX5530

InGaP HBT 4.5 – 6.0GHz Power Amplifier **PRODUCTION DATA SHEET**

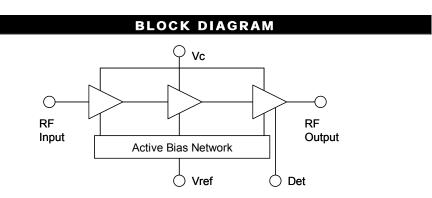
DESCRIPTION

The LX5530 is a power amplifier The device is manufactured with an -40 to +85°C. InGaP/GaAs Heterojunction Bipolar Transistor (HBT) IC spectrum mask compliance, and low the EVM of 3% for up to +23dBm output applications. power in the 4.9-5.9GHz band.

The LX5530 also features an on-chip optimized for the FCC Unlicensed power detector at the output port of the National Information Infrastructure PA to help reduce BOM cost and PCB (U-NII) band, HyperLAN2 and Japan space for implementation of power WLAN applications in the 4.9 - 5.9 control in a typical wireless system. The GHz frequency range. The PA is power detector is integrated with a implemented as a three-stage monolithic temperature-compensated bias network microwave integrated circuit (MMIC) and provides very stable response with active bias, on-chip input across a wide range of output power matching and output pre-matching. levels, over temperature extremes from

The LX5530 is available in a 16-pin process 3mmx3mm micro-lead package (MLP). (MOCVD). It operates with a single The compact footprint, low profile, and positive voltage supply of 3 - 5V, excellent thermal capability makes the with high power gain of up to 33dB. LX5530 an ideal solution for When operated at 5V supply voltage, broadband, high-gain power amplifier it provides up to +25dBm linear requirements for IEEE 802.11a, and output power for 802.11a OFDM Hiperlan2 portable WLAN, as well as emerging 802.16 WiMAX

IMPORTANT: For the most current data, consult MICROSEMI's website: http://www.microsemi.com

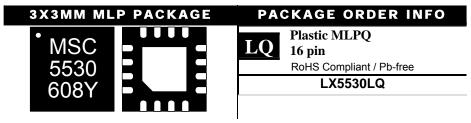


KEY FEATURES

- Broadband 4.9 5.9GHz Operation
- . Advanced InGaP HBT
- Single-Polarity 3 5V Supply Power Gain up to ~ 33dB for
- $V_{c}=5V$, lcg = 250mA Power Gain > ~28dB across 4.9-5.85GHz
- **OFDM Mask Compliance Power** Pout ~ +25dBm over 4.9-5.85GHz (ACPR ~ -50dBc @ ±30MHz Offset)
- Pout up to +23dBm with EVM $\sim 3\% (V_{\rm C} = 5V)$
- EVM < ~2.5% for Pout=+21dBm across 4.9- $5.85GHz (V_{C} = 5V)$
- EVM < ~2.5% for Pout=+19dBm across 4.9- $5.85GHz (V_{c} = 4V)$
- Total Current ~250mA for Pout = +20dBm, Duty Cycle = 99% $(V_{C}=4V)$
- Complete On-Chip Input Match
- Simple Output Match for Optimal Broadband EVM
- **On-Chip RF Decoupling**
- Temperature-Compensated On-Chip Output Power Detector with Wide Dynamic Range
- Small Footprint: 3x3mm
- Low Profile: 0.9mm

APPLICATIONS

- FCC U-NII Wireless
 - IEEE 802.11a
- HiperLAN2 .
- 5GHz Cordless Phone
- IEEE 802.16 WIMAX



Note: Available in Tape & Reel. Append the letters TR" to the part number. (i.e. LX5530LQ-TR)



INFORMATION

Thank you for your interest in Microsemi[®] IPG products.

The full data sheet for this device contains proprietary information.

To obtain a copy, please contact your local Microsemi sales representative. The name of your local representative can be obtained at the following link http://www.microsemi.com/contact/contactfind.asp

or

Contact us directly by sending an email to:

IPGdatasheets@microsemi.com

Be sure to specify the data sheet you are requesting and include your company name and contact information and or vcard.

We look forward to hearing from you.